



IPR Notice

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This presentation contains forward-looking statements, which are subject to risk factors associated with semiconductor and intellectual property business. It is believed that the expectations reflected in these statements are reasonable. But they may be affected by a variety of variables, many of which are beyond our control. These variables could cause actual results or trends to differ materially which include, but are not limited to: wafer price fluctuation, actual demand, rapid technology change, delays or failures of customers' tape-outs into wafer production, our ability to negotiate, monitor and enforce agreements for the determination and payment of royalties, any bug or fault in our technology which leads to significant damage to our technology and reputation, actual or potential litigation, semiconductor industry cycle and general economic conditions. Except as required by law, eMemory undertakes no obligation to update or revise any forward-looking statements, whether as a result of new information, future events, or otherwise.



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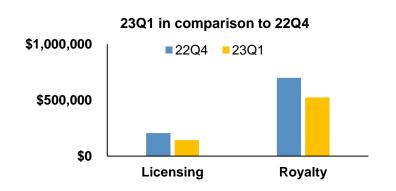
Q1 2023 Financial Results

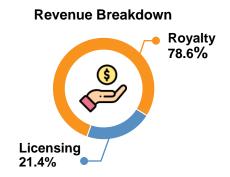
(thousands of NT dollars)

	Q1 2023	Q4 2022	QoQ	Q1 2022	YoY
Revenue	667,751	902,704	-26.0%	727,107	-8.2%
Gross Margin	100%	100%	-	100%	-
Operating Expenses	300,657	368,090	-18.3%	313,846	-4.2%
Operating Income	367,094	534,614	-31.3%	413,261	-11.2%
Operating Margin	55.0%	59.2%	-4.2 ppts	56.8%	-1.8 ppts
*Net Income	313,090	430,536	-27.3%	366,019	-14.5%
Net Margin	46.1%	47.6%	-1.5 ppts	49.8%	-3.7 ppts
EPS (NT\$)	4.20	5.77	-27.2%	4.91	-14.5%
ROE	38.9%	62.2%	-23.3 ppts	55.0%	-16.1 ppts

^{*}Net income attributable to Shareholders of the Company

Revenue across Different Streams





Revenue

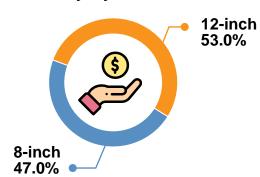
NT\$ Thousands	Q1 2023	Q4 2022	Change (QoQ)	Q1 2022	Change (YoY)
Licensing	143,049	205,104	-30.3%	191,608	-25.3%
Royalty	524,702	697,600	-24.8%	535,499	-2.0%
Total	667,751	902,704	-26.0%	727,107	-8.2%

Revenue by **Technology**

		Q1 2023								
	Total Revenue			Lice	Licensing Revenue			Royalty Revenue		
Technology	% of Q1 Revenue	Change (QoQ)	Change (YoY)	% of Q1 Licensing	Change (QoQ)	Change (YoY)	% of Q1 Royalty	Change (QoQ)	Change (YoY)	
NeoBit	28.2%	-30.0%	-22.7%	19.7%	-22.6%	-19.8%	30.5%	-31.1%	-23.2%	
NeoFuse	63.9%	-22.4%	-0.8%	49.6%	-28.5%	-42.9%	67.8%	-21.0%	16.3%	
PUF-Based	2.5%	-63.6%	126.6%	11.5%	-60.7%	138.2%	0.0%	-93.8%	-46.3%	
МТР	5.4%	-5.6%	-21.7%	19.2%	0.0%	8.4%	1.7%	-19.8%	-58.2%	

Royalty Revenue by Wafer Size

Q1 Royalty Breakdown



- 8-inch wafers contributed 47% of royalty, down 25.5% sequentially and down 9.2% yearly.
- 12-inch wafers contributed 53% of royalty, down 24.1% QoQ but up 5.3% YoY.

Mafar Cina		Q1 2023	
Wafer Size	% of Q1	Change (QoQ)	Change (YoY)
8-Inch	47.0%	-25.5%	-9.2%
12-Inch	53.0%	-24.1%	5.3%



Future Outlook

Licensing & Royalty:

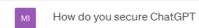
- Licensing will significantly grow during the rest of the year, driven by PUFbased security solutions.
- With more than 1000 new products tape out in the pipeline, royalty will regain growth momentum as new tape outs move into production.

New IP Technology & Business Development:

- This year, PUF-based solutions will be adopted in 5/6/7nm CPU, DPU, AI and Automotive-related applications.
- Continue working with foundries to develop NeoFlash to increase the penetration rate of mature processes.
- Continue developing PUF-based security solutions in the most advanced processes with CPU partners.



Asking ChatGPT about Security.







As an Al language model, ChatGPT is secured through various measures that are designed to ensure the confidentiality, integrity, and availability of the system. Here are some of the ways ChatGPT is secured:

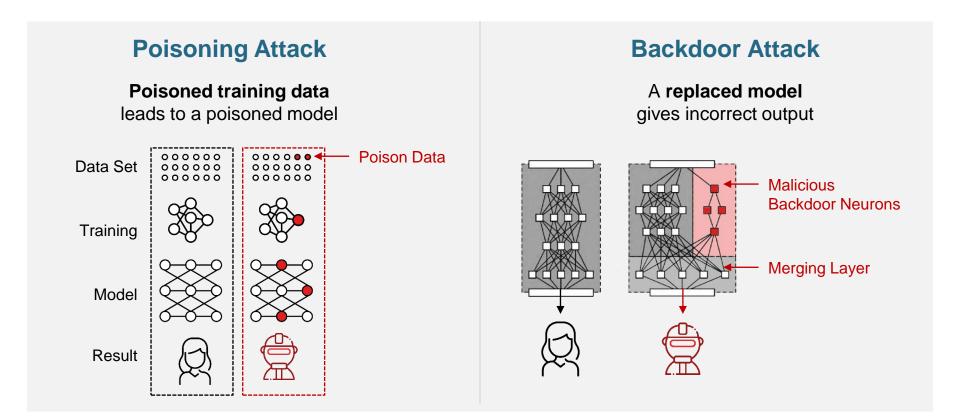




- 1. Data Encryption: All the data exchanged between the user and ChatGPT is encrypted using industry-standard encryption protocols. This helps to protect the data from unauthorized access or interception.
- 2. Access Control: Access to ChatGPT is restricted to authorized personnel only. Authentication mechanisms such as username and password are used to ensure that only authorized users can access the system.
- 3. Auditing and Logging: ChatGPT logs all user activities and interactions, including user inputs and system outputs. This helps to identify and investigate any security incidents or breaches.
- Regular Updates: ChatGPT is regularly updated with the latest security patches and fixes. This helps to mitigate any known security vulnerabilities and keep the system secure.
- 5. Training and Awareness: All personnel involved in the operation and maintenance of ChatGPT undergo regular security awareness training to help them identify and mitigate potential security threats.

	Use PUF-based Security					
1	Key generation for encryption					
2	Unique Identity (UID) and Secret Key generation for authentication					
3	ID generation for users					
4	Secure over-the-air (OTA) firmware/software updates through signature verification					
5	Mitigate human errors by hardware security					

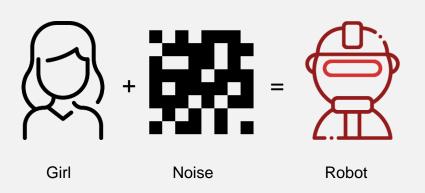
Major Attacks in Al -



Major Attacks in Al cont.

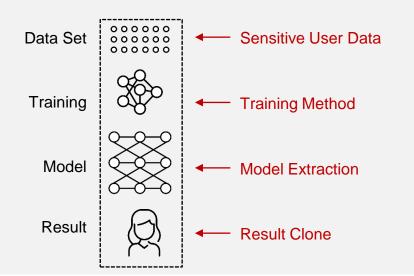
Evasion Attack

Al model mis-performs due to **modified Input Data or Inference Results**



Stealing Attack

Hacker **steals Al know-how** including data, model parameters, or sensitive information



How to **Prevent Attacks** on **AI**.

- Each of these types of attacks requires different protection methods
- PUF-based security co-processor, PUFcc, can well protect AI systems

Types	s of Attacks	Problems	Solution	
	Poisoning Attack	Training data may be corrupted	Signing the training data	
	Backdoor Attack	Model may be modified, replaced, or even stolen by attackers	Signing the modelEncryption and Key management	

How to **Prevent Attacks** on **AI** cont.

- Each of these types of attacks requires different protection methods
- PUF-based security co-processor, PUFcc, can well protect AI systems

Types of Attacks		Problems	Security Solution	
	Evasion Attack	Attacker can tamper input data to wreck the model, or tamper with the inference result	 Authenticate and provision users (UID) Encryption and Key management 	
	Stealing Attack	Hardware implementations of AI are prone to hacking and theft, including training data, model and inference result	 Authenticate provision users (UID) Signing model/data Encryption and Key management Anti-tamper hardware design 	

Securing AI with **PUF-based** Solutions -

PUF-based IPs provide comprehensive protection to safeguard AI applications

Best in-class Root of Trust



- Secure OTP Qualified Worldwide
- High performance TRNG
- High quality on-chip PUF fingerprint
- Controller and flexible interfacing

Complete set of Cryptographic Engines



- Symmetric ciphers (AES)
- Public Key cryptography (RSA/ECC)
- Secure hashing (SHA-2)
- Key wrapping and derivation

Certified Anti-tampering Designs



- Data/address scrambling
- Output data fault detection
- Side-channel attack countermeasures

Advanced Security Protocols and Applications



- Secure boot
- Transport Layer Security (TLS)
 Protocol
- Key management
- Anti-cloning and asset protection



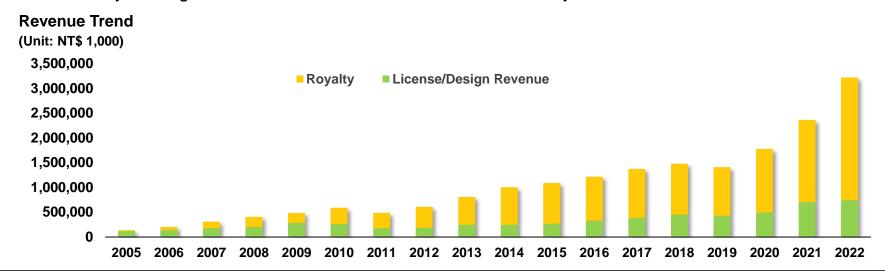


Q&A



Company Overview

eMemory is the global leader of embedded non-volatile memory IP



Founded In 2000

Based in Hsinchu, Taiwan. IPO in 2011. Over 50M wafers shipped.

Patents Issued

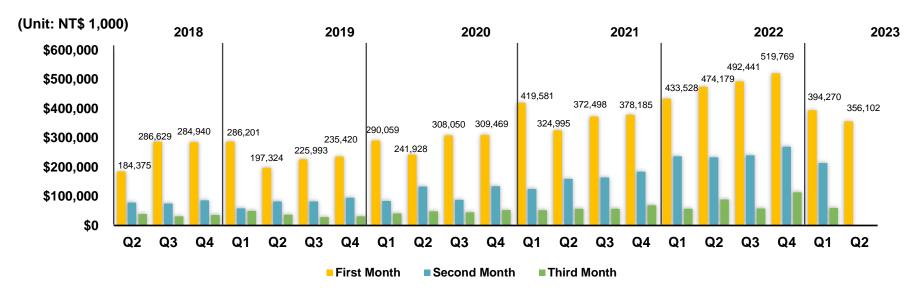
199 pending patents. 334 employees with 67% R&D personnel.

t IP Partner With TSMC

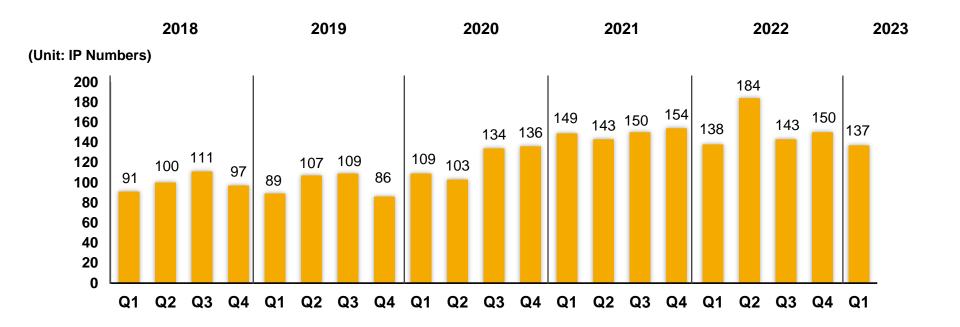
TSMC Best IP Partner Award since 2010.

Quarterly Revenue Pattern

- 1st month: Receive License Fees of the month and Royalty from most foundries on previous quarter's wafer shipments.
- 2nd month: Receive License Fees of the month and Royalty from other foundries.
- 3rd month: License Fees Only.



Quarterly Number of New Tape-outs



Worldwide Customers

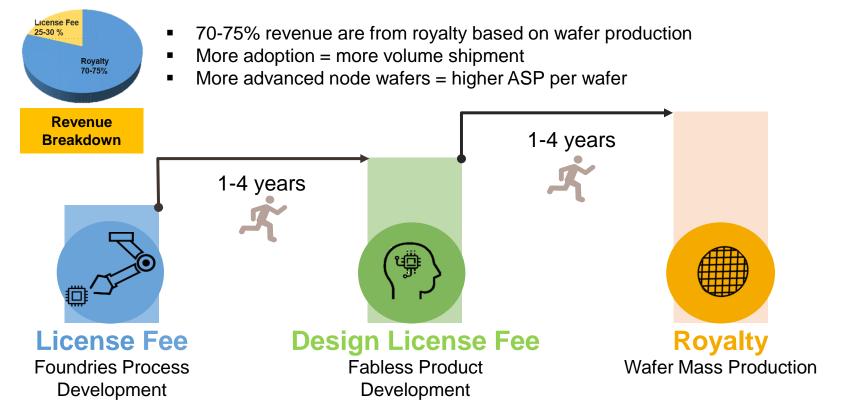
Our IP solutions are adopted by leading foundries, IDMs and fabless worldwide

Country	Foundry	IDM	Fabless
Taiwan	4	1	323
China	9	0	1105
Korea	4	0	96
Japan	4	7	80
North America	1	1	365
Europe	2	1	211
Others	1	0	103



Business Model

Recurring royalty is the backbone of our business

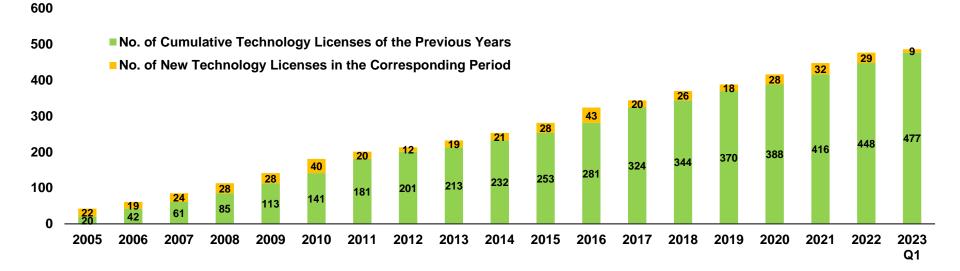


Technology Licenses

Number of Licenses

Year	2016	2017	2018	2019	2020	2021	2022	2023 Q1
License	43	20	26	18	28	32	29	9

Note: Terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.



New Technology Under Development

- New technologies are being developed for 140 platforms by Q1 2023.
- 9 licensing contracts were signed.

Technology	3nm	4/5nm	6/7nm	12/16nm	22/28nm	40nm	55/65nm	80/90nm	0.11~ 0.13um	0.15~ 0.18um	>0.25um
NeoBit		-	-	-	-	-	2	1	14	11	1
NeoFuse	2	2	1	7	11	6	17	7	2	3	-
PUF-Based	-	2	-	-	1	-	1	-	-	-	-
МТР	-	-	-	-	2	1	8	7	13	18	-

Note: As of March 31st, 2023

Technology Development

Developments by process nodes

12" Fabs	Production	Development	IP Type	Process Type
3nm	0	2	OTP	FF
4/5nm	2	4	OTP, PUF	FF
6/7nm	4	1	OTP, PUF	FF, FF+
12/16nm	8	7	OTP, PUF	FF, FF+, FFC. FFC+, LPP, DRAM
22/28nm	44	14	OTP, PUF ,MTP	LP/ULP/ULL, HPC/HPC+, HV-OLED, DRAM, SOI, ReRAM, MRAM, E-Flash, BCD
40nm	22	7	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED, ReRAM
55/65nm	38	28	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED, DRAM, CIS, BCD, PM
80/90nm	23	12	OTP, MTP	HV-DDI/OLED, LP, Generic ,BCD, CIS
0.11/0.13um	20	3	OTP, MTP	HV-DDI, BCD, Generic
0.15/0.18um	2	11	OTP, MTP	BCD, Generic
Total	163	89		

8" Fabs	Production	Development	IP Type	Process Type
80/90nm	9	3	ОТР	HV-DDI, LL, BCD
0.11/0.13um	76	26	OTP, MTP, PUF	HV/HV-MR, BCD, LP/LL, CIS, Green, Flash, SOI, Generic
0.152/0.16/0.18um	225	21	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Generic
0.25um	42	1	ОТР	BCD
0.3/0.35um	53	0	OTP, MTP	UHV, BCD
0.4/0.5um	11	0	ОТР	UHV, BCD
Total	416	51		

Note: As of March 31st, 2023

